

## Features

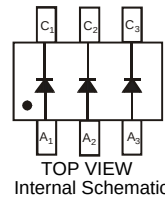
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- **Lead Free/RoHS Compliant (Note 3)**
- **"Green" Device (Notes 4 and 5)**

## Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.006 grams (approximate)



SOT-363



## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                            | Symbol              | Value | Unit |
|-------------------------------------------|---------------------|-------|------|
| Non-Repetitive Peak Reverse Voltage       | V <sub>RM</sub>     | 100   | V    |
| Peak Repetitive Reverse Voltage           | V <sub>RRM</sub>    | 75    | V    |
| Working Peak Reverse Voltage              | V <sub>RWM</sub>    |       |      |
| DC Blocking Voltage                       | V <sub>R</sub>      |       |      |
| RMS Reverse Voltage                       | V <sub>R(RMS)</sub> | 53    | V    |
| Forward Continuous Current (Note 1)       | I <sub>FM</sub>     | 300   | mA   |
| Average Rectified Output Current (Note 1) | I <sub>O</sub>      | 150   | mA   |
| Non-Repetitive Peak Forward Surge Current | I <sub>FSM</sub>    | 2.0   | A    |
|                                           |                     | 1.0   |      |

## Thermal Characteristics

| Characteristic                                      | Symbol                            | Value       | Unit |
|-----------------------------------------------------|-----------------------------------|-------------|------|
| Power Dissipation (Note 1)                          | P <sub>D</sub>                    | 200         | mW   |
| Thermal Resistance Junction to Ambient Air (Note 1) | R <sub>θJA</sub>                  | 625         | °C/W |
| Operating and Storage Temperature Range             | T <sub>J</sub> , T <sub>STG</sub> | -65 to +150 | °C   |

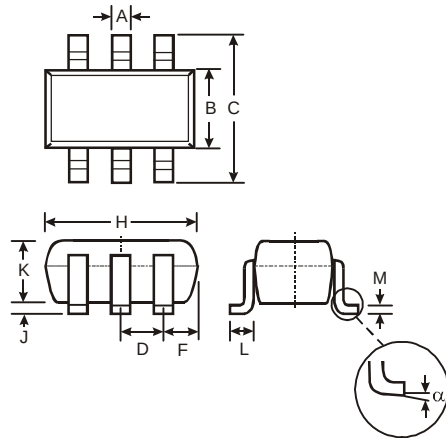
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                     | Symbol             | Min | Max                           | Unit                 | Test Condition                                                                                                                               |
|------------------------------------|--------------------|-----|-------------------------------|----------------------|----------------------------------------------------------------------------------------------------------------------------------------------|
| Reverse Breakdown Voltage (Note 2) | V <sub>(BR)R</sub> | 75  | —                             | V                    | I <sub>R</sub> = 1μA                                                                                                                         |
| Forward Voltage                    | V <sub>F</sub>     | —   | 0.715<br>0.855<br>1.0<br>1.25 | V                    | I <sub>F</sub> = 1.0mA<br>I <sub>F</sub> = 10mA<br>I <sub>F</sub> = 50mA<br>I <sub>F</sub> = 150mA                                           |
| Reverse Current (Note 2)           | I <sub>R</sub>     | —   | 1.0<br>50<br>30<br>25         | μA<br>μA<br>μA<br>nA | V <sub>R</sub> = 75V<br>V <sub>R</sub> = 75V, T <sub>J</sub> = 150°C<br>V <sub>R</sub> = 25V, T <sub>J</sub> = 150°C<br>V <sub>R</sub> = 20V |
| Total Capacitance                  | C <sub>T</sub>     | —   | 2.0                           | pF                   | V <sub>R</sub> = 0, f = 1.0MHz                                                                                                               |
| Reverse Recovery Time              | t <sub>rr</sub>    | —   | 4.0                           | ns                   | I <sub>F</sub> = I <sub>R</sub> = 10mA,<br>I <sub>rr</sub> = 0.1 x I <sub>R</sub> , R <sub>L</sub> = 100Ω                                    |

- Notes:
1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. Short duration pulse test used to minimize self-heating effect.
  3. No purposefully added lead.
  4. Diodes Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
  5. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

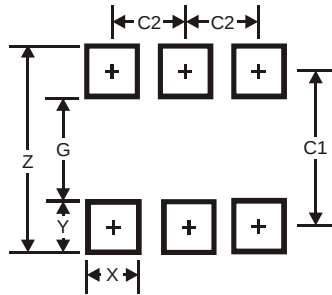


## Package Outline Dimensions



| SOT-363              |          |      |
|----------------------|----------|------|
| Dim                  | Min      | Max  |
| A                    | 0.10     | 0.30 |
| B                    | 1.15     | 1.35 |
| C                    | 2.00     | 2.20 |
| D                    | 0.65 Typ |      |
| F                    | 0.40     | 0.45 |
| H                    | 1.80     | 2.20 |
| J                    | 0        | 0.10 |
| K                    | 0.90     | 1.00 |
| L                    | 0.25     | 0.40 |
| M                    | 0.10     | 0.22 |
| $\alpha$             | 0°       | 8°   |
| All Dimensions in mm |          |      |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 2.5           |
| G          | 1.3           |
| X          | 0.42          |
| Y          | 0.6           |
| C1         | 1.9           |
| C2         | 0.65          |

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